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RoHS



Vishay General Semiconductor

Surface Mount Ultrafast Rectifier



DO-214AC (SMA)

PRIMARY CHARACTERISTICS					
I _{F(AV)}	1.0 A				
V_{RRM}	100 V, 150 V, 200 V				
I _{FSM}	30 A				
t _{rr}	25 ns				
V_F at $I_F = 1.0 A$	0.76 V				
T _J max.	175 °C				

FEATURES

- Low profile package
- · Ideal for automated placement
- Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds AC/AC and DC/DC converters in high temperature conditions for both consumer and automotive applications.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Delevitor Calar band denates actionals and

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	UH1B	UH1C	UH1D	UNIT	
Device marking code		НВ	HC	HD		
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V	
Maximum average forward rectified current (fig. 1)	I _{F(AV)}	1.0			Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30			А	
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 175			°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIO	TEST CONDITIONS		TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 0.6 A	T _A = 25 °C	V _F ⁽¹⁾	0.90	=.	V	
	I _F = 1.0 A			0.96	1.05		
	I _F = 0.6 A	T _Δ = 125 °C		0.70	-		
	I _F = 1.0 A	1A = 123 C		0.76	0.90		
Reverse current	Rated V _R	$T_A = 25 ^{\circ}C$	I _R ⁽²⁾	-	1.0	μΑ	
	nated V _R	T _A = 125 °C		7.5	25		
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	T _A = 25 °C	T _A = 25 °C t _{rr}	13	25	ns	
Typical reverse recovery time	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$			21	30		
Typical softness factor (t _b /t _a)		T _A = 125 °C	S	0.8	-	-	
Typical reverse recovery current	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 200 \text{ A/}\mu\text{s}, $ $V_B = 200 \text{ V}$		I _{RM}	2.7	4.0	Α	
Typical stored charge			Q _{rr}	35	-	nC	
Typical junction capacitance	4.0 V, 1 MHz		CJ	17	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL UH1B UH1C UH1D			UNIT	
Typical thermal resistance	R _{0JA} (1)	120			°C/W
Typical trieffial resistance	R _{0JM} (1)	20			

Note

 $^{(1)}$ Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
UH1D-E3/61T	0.064	61T	1800	7" diameter plastic tape and reel		
UH1D-E3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel		
UH1DHE3/61T (1)	0.064	61T	1800	7" diameter plastic tape and reel		
UH1DHE3/5AT (1)	0.064	5AT	7500	13" diameter plastic tape and reel		
UH1DHE3_A/H (1)	0.064	Н	1800	7" diameter plastic tape and reel		
UH1DHE3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

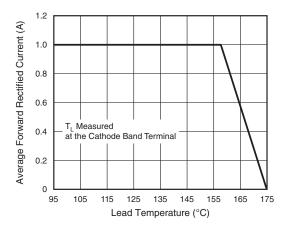


Fig. 1 - Maximum Forward Current Derating Curve

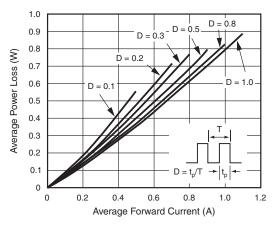


Fig. 2 - Forward Power Loss Characteristics

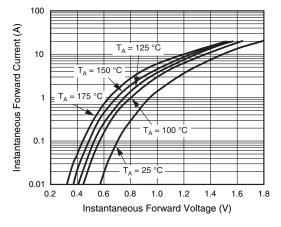


Fig. 3 - Typical Instantaneous Forward Characteristics

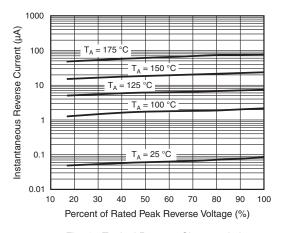


Fig. 4 - Typical Reverse Characteristics

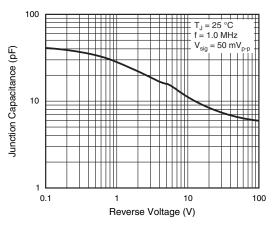


Fig. 5 - Typical Junction Capacitance

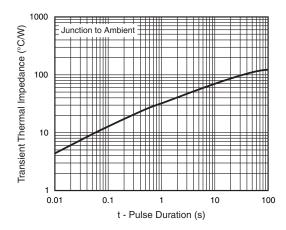


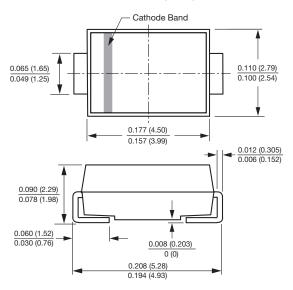
Fig. 6 - Typical Transient Thermal Impedance



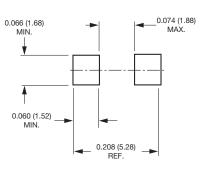
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





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